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捷多邦,专业PCB打样工厂,24小**环4A急VGHS162830A 1-BIT TO 2-BIT ADDRESS DRIVER** WITH 3-STATE OUTPUTS SCES624 - FEBRUARY 2005

● Member of the Texas Instruments Widebus™ Family	DBB PACKAGE (TOP VIEW)
 Output Ports Have Series Damping Resistors, So No External Resistors Are Required 	2Y2 1 80 1Y3 1Y2 2 79 2Y3 GND 3 78 GND
 Diodes on Inputs Clamp Overshoot 	2Y1 4 77 1 1Y4
 Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors 	1Y1 5 76 2Y4 V _{CC} 6 75 V _{CC} A1 7 74 1Y5
 Latch-Up Performance Exceeds 250 mA Per JESD 17 	A2 [] 8 73 [] 2Y5 GND [] 9 72 [] GND
 ESD Protection Exceeds JESD 22 2000-V Human-Body Model (A114-A) 200-V Machine Model (A115-A) 	A3 [] 10 71 [] 1Y6 A4 [] 11 70 [] 2Y6 GND [] 12 69 [] GND
description/ordering information	A5 [] 13 68 [] 1Y7 A6 [] 14 67 [] 2Y7
This 1-bit to 2-bit address driver is designed for 2.3-V to 3.6-V V _{CC} operation.	V _{CC} [15 66] V _{CC} A7 [16 65] 1Y8 A8 [17 64] 2Y8
Diodes to V _{CC} have been added on the inputs to clamp overshoot.	GND [] 18 63] GND <u>A9</u> [] 19 62] 1Y9 OE1 [] 20 61 [] 2Y9
Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.	OE1 0 61 219 OE2 21 60 1Y10 A10 22 59 2Y10 GND 23 58 GND A11 24 57 1Y11
The outputs, which are designed to sink up to 12 mA, include series damping resistors to reduce overshoot and undershoot.	A12 25 56 2Y11 V _{CC} 26 55 V _{CC} A13 27 54 1Y12
The ALVCHS162830A is an improved version of the LVCHS162830 (non-A version) and has been optimized for lower power consumption and higher AC drive. Higher AC drive provides capability to drive loads with a faster edge rate.	A14 [28 53] 2Y12 GND [29 52] GND A15 [30 51] 1Y13 A16 [31 50] 2Y13 GND [32 49] GND A17 [33 48] 1Y14
To ensure the high-impedance state during power up or power down, the output-enable (\overline{OE}) input should be tied to V _{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.	A17 [33 48 1114 A18] 34 47] 2Y14 V _{CC}] 35 46 V _{CC} 2Y18] 36 45] 1Y15 1Y18] 37 44] 2Y15 GND] 38 43] GND 2Y17] 39 42] 1Y16 1Y17 [40 41] 2Y16



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description/ordering information

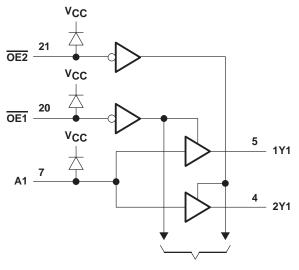
ORDERING INFORMATION

TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING						
-40°C to 85°C	TVSOP – DBB	Tape and reel	74ALVCHS162830AGR	ALVCHS162830A						

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

	FUNCTION TABLE								
	INPUTS		OUT	PUTS					
OE1	OE2	Α	1Yn	2Yn					
L	Н	Н	Н	Ζ					
L	Н	L	L	Z					
н	L	Н	Z	Н					
н	L	L	Z	L					
L	L	Н	н	Н					
L	L	L	L	L					
Н	Н	Х	Z	Z					

logic diagram (positive logic)



To 17 Other Channels



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	
Input voltage range, V _I (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Notes 1 and 2)	–0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} (V _I < 0, V _I > V _{CC})	±50 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, I _O	±50 mA
Continuous current through each V _{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3)	
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 4.6 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
VCC	Supply voltage		2.3	3.6	V
	LPark Jacob Sanatan Ita wa	V_{CC} = 2.3 V to 2.7 V	1.7		
VIH	High-level input voltage	V_{CC} = 2.7 V to 3.6 V	2		V
	Level level level to a level	V_{CC} = 2.3 V to 2.7 V		0.7	
VIL	Low-level input voltage $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$			0.8	V
VI	Input voltage		0	VCC	V
Vo	Output voltage		0	VCC	V
		$V_{CC} = 2.3 V$		-6	
ЮН	High-level output current	$V_{CC} = 2.7 V$		-8	mA
		$V_{CC} = 3 V$		-12	
		V _{CC} = 2.3 V		6	
IOL	Low-level output current	$V_{CC} = 2.7 V$		8	mA
			12		
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V
ТА	Operating free-air temperature		-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARA	METER	TEST C	ONDITIONS	Vcc	MIN	TYP†	MAX	UNIT	
		lj = –18 mA	2.3 V			-1.2			
VIK		lj = 18 mA		2.3 V		VC	ე + 1.2	V	
		I _{OH} = -100 μA		2.3 V to 3.6 V	V _{CC} –	0.2			
		I _{OH} = -4 mA,	VIH = 1.7 V	2.3 V	1.9				
			V _{IH} = 1.7 V	2.3 V	1.7				
VOH		$I_{OH} = -6 \text{ mA}$	V _{IH} = 2 V	3 V	2.4			V	
		I _{OH} = -8 mA,	V _{IH} = 2 V	2.7 V	2				
		I _{OH} = -12 mA,	V _{IH} = 2 V	3 V	2				
		l _{OL} = 100 μA		2.3 V to 3.6 V			0.2		
		I _{OL} = 4 mA,	V _{IL} = 0.7 V	2.3 V			0.4		
			VIL = 0.7 V	2.3 V			0.55	V	
VOL		$I_{OL} = 6 \text{ mA}$	V _{IL} = 0.8 V	3 V			0.55		
		I _{OL} = 8 mA,	V _{IL} = 0.8 V	2.7 V			0.6		
		I _{OL} = 12 mA,	V _{IL} = 0.8 V	3 V			0.8		
lj		$V_{I} = V_{CC}$ or GND		3.6 V			±5	μA	
		V _I = 0.7 V		2.3 V	45				
		V _I = 1.7 V		2.3 V	-45				
ll(hold)		V _I = 0.8 V		3 V	75			μA	
((()))		V _I = 2 V		3 V	-75			•	
		$V_{I} = 0$ to 3.6 V [‡]		3.6 V			±500		
I _{OZ}		$V_{O} = V_{CC}$ or GND		3.6 V			±10	μA	
ICC		$V_{I} = V_{CC} \text{ or GND},$	$I_{O} = 0$	3.6 V			20	μA	
∆ICC			Other inputs at V _{CC} or GND	3 V to 3.6 V			500	μA	
(Control inputs			1		3.5		pF	
C: -	Data inputs	V _I = V _{CC} or GND		3.3 V		4.5			
	Jutputs	$V_{O} = V_{CC}$ or GND		3.3 V		4.5		pF	

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25° C.

[‡]This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

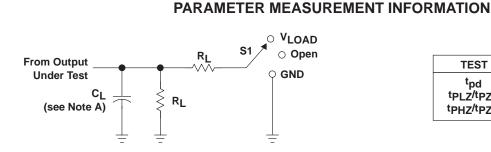
PARAMETER	FROM	TO	V _{CC} = ± 0.2	2.5 V 2 V	V _{CC} =	2.7 V	۲ <mark>0.5 V_{CC} =</mark>	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	А	Y	1.2	3.8		4	1.7	3.5	ns
ten	OE	Y	1	5.7		5.7	1	4.8	ns
^t dis	OE	Y	1	4.9		5.4	1.7	5.2	ns

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER			TEST C	ONDITIONS	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT
Γ	<u> </u>	Power dissipation capacitance	One OE enabled	0.0	f = 10 MHz	17	17.5	~ F
	C _{pd}	per bit (one output switching)	All outputs disabled	$C_{L} = 0,$		0.4	0.5	pF



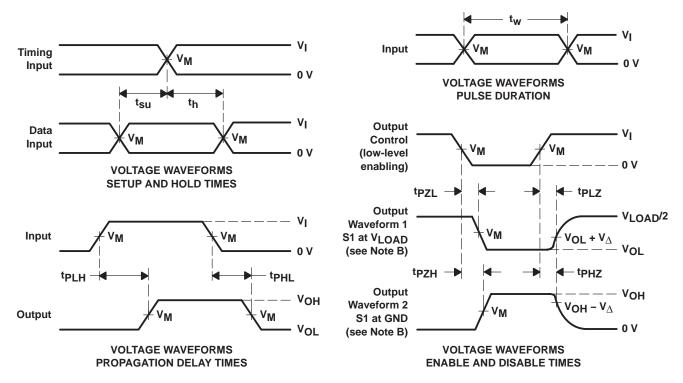
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LOAD CIRCUIT

TEST	S1
^t pd	Open
tPLZ/tPZL	V _{LOAD}
tPHZ/tPZH	GND

N N	IN	PUT	N	V	0	P	V
Vcc	VI	t _r /t _f	VМ	VLOAD	СL	RL	v_Δ
$\textbf{2.5 V} \pm \textbf{0.2 V}$	V _{CC}	≤2 ns	V _{CC} /2	$2 \times V_{CC}$	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
$\textbf{3.3 V} \pm \textbf{0.3 V}$	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω .
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





27-Sep-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ALVCHS162830AGR	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
ALVCHS162830AGRE4	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
ALVCHS162830AGRG4	ACTIVE	TSSOP	DBB	80	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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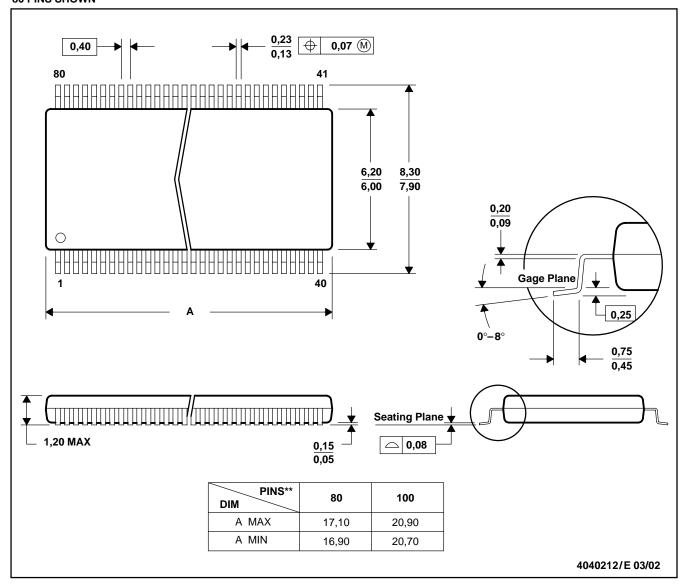
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MECHANICAL DATA

MTSS005D - JANUARY 1995 - REVISED MARCH 2002

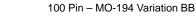
PLASTIC SMALL-OUTLINE PACKAGE

DBB (R-PDSO-G**) 80 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC : 80 Pin MO-153 Variation FF





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